

# LNP129021

## Pandel Display Units

### RG Type

#### ■ Structure

- Illumination color: Red, Green, Amber (Red and Green lighting)
- Display surface: 239.8 mm × 239.8 mm
- Number of dots (dot): 256 (16 × 16 dot)
- Dot size: 13 mm × 13 mm
- Dot pitch: 15.0 mm

#### ■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Operating supply voltage	$V_{CC}$	-0.3 to +5.5	V
LED operating supply voltage	$V_{LEDA}$	+5.5	V
Input voltage	$V_{IN}$	-0.3 to $V_{CC} + 0.3$	V
Operating ambient temperature	$T_{opr}$	-20 to +45	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-30 to +80	$^\circ\text{C}$

#### ■ Recommending Operating Conditions $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

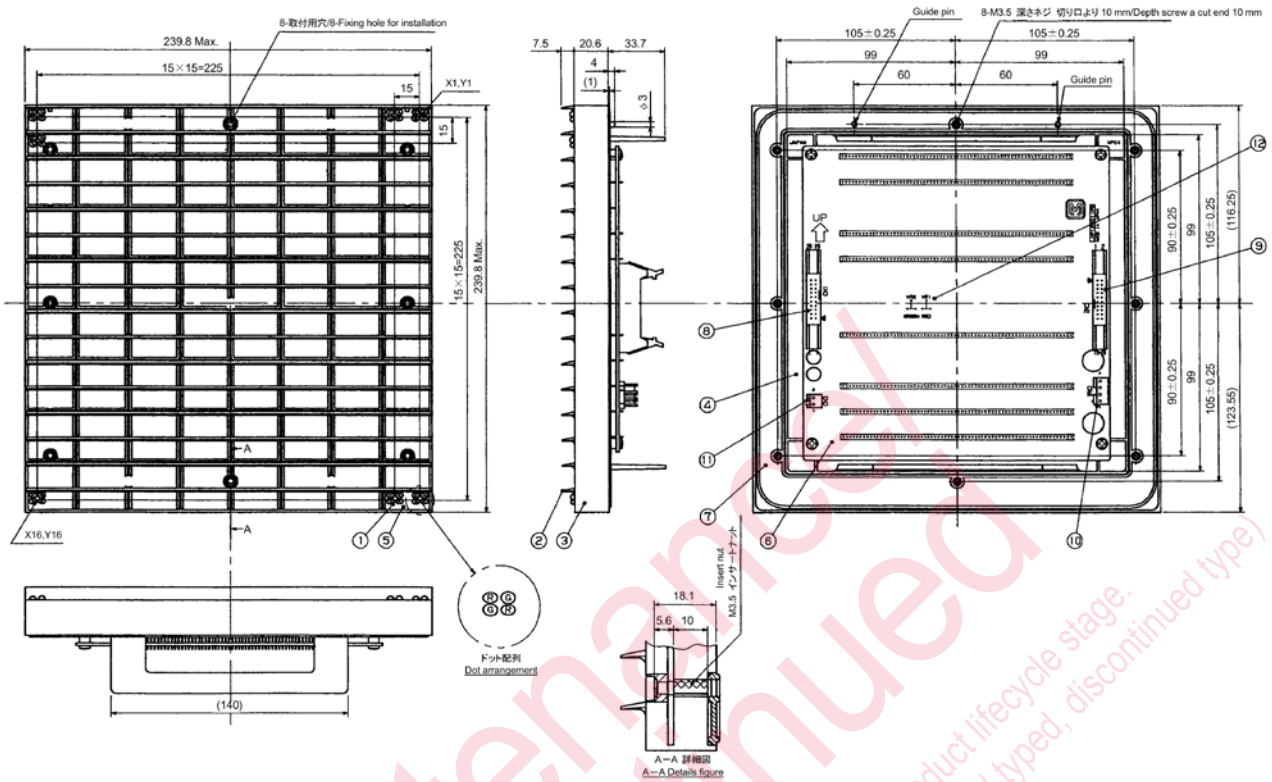
Parameter	Symbol	Min	Typ	Max	Unit
Operating supply voltage	$V_{CC}$	4.75	5.0	5.25	V
LED operating supply voltage	$V_{LEDA}$	5.10	5.2	5.30	V
Input voltage	$V_{IN}$	0.0	—	$V_{CC}$	V

#### ■ Electro-Optical Characteristics $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$ , $V_{CC} = 5.0\text{ V}$ , $V_{LEDA} = 5.2\text{ V}$

Parameter	Symbol	Specification		Unit
Brightness	—	Red	Typ. 1800	$\text{cd}/\text{m}^2$
		Green	Typ. 1000	$\text{cd}/\text{m}^2$
Peak emission wavelength	$\lambda_p$	Red	Typ. 650	nm
		Green	Typ. 565	nm
Viewing angle	$2\theta_{1/2}$	Direction of right and left	$\geq 120$	$^\circ$
Drive system	—	Static driving		—
Clock frequency	$f_{CLK}$	Max. 5		MHz
Supply current (Logic) *	$I_{CC(Logic)}$	Max. 1.5		A
Supply current (LED) *	$I_{CC(LED)}$	Max. 10.5		A

Note) \*: Two-color all lighting

■ Package (Unit: mm)



● Part name

1. LED
2. Hood
3. Frame
4. Display board
5. Water proof resin
6. Driver board
7. Water proof packing
8. Signal connector (input)
9. Signal connector (output)
10. Supply connector (LED)
11. Supply connector (Logic)
12. Volume

Maintenance/Discontinued

Maintenance/Discontinued includes following four Product lifecycle stage.  
(planned maintenance type, maintenance type, planned discontinued type, discontinued type)

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